

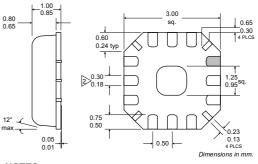
# **RF2416**

#### **Typical Applications**

- GSM/DCS Dual-Band Handsets
- Cellular/PCS Dual-Band Handsets
- General Purpose Amplification
- Commercial and Consumer Systems

#### **Product Description**

The RF2416 is a dual-band low noise amplifier with bypass switch designed for use as a front-end for 950MHz GSM and DCS1800/PCS1900 applications. It may also be used for dual-band cellular/PCS application. The 900MHz LNA is a single-stage amplifier with bypass switch; the 1800/1900 LNA is a two-stage amplifier with bypass switch. Both amplifiers have excellent noise figure and high linearity in both high gain and bypass/low gain mode. The device is packaged in a 3mmx3mm, 12 pin, leadless chip carrier.



#### NOTES:

Shaded Pin is Lead 1

Dimension applies to plated terminal and is measured between 0.02 mm and 0.25 mm from terminal end.

3 Pin 1 identifier must exist on top surface of package by identification mark or feature on the package body. Exact shape and size is optional.

Package Warpage: 0.05 mm max.

5 Die thickness allowable: 0.305 mm max

#### Package Style: LCC, 12-Pin, 3x3

#### **Features**

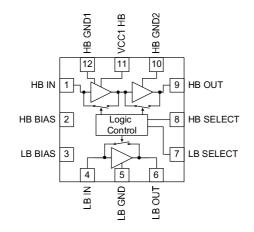
- Low Noise and High Intercept Point
- Dual-Band Application GSM900 and DCS1800/PCS1900
- Power Down Control
- Switchable Gain

#### **Ordering Information**

RF2416 Dual-Band 2.7 V Low Noise Amplifier RF2416 PCBA Fully Assembled Evaluation Board RF Micro Devices, Inc. Tel (336) 664 1233 7628 Thorndike Road Fax (336) 664 0454 Greensboro, NC 27409, USA http://www.rfmd.com

#### **Optimum Technology Matching® Applied** GaAs MESFET

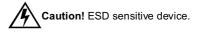
Si BJT	🖌 GaAs HBT	GaAs MES
Si Bi-CMOS	SiGe HBT	Si CMOS



#### **Functional Block Diagram**

#### **Absolute Maximum Ratings**

Parameter	Rating	Unit
Supply Voltage	-0.5 to +6.0	V <sub>DC</sub>
Input RF Level	+10	dBm
Storage Temperature	-40 to +150	°C



RF Micro Devices believes the furnished information is correct and accurate at the time of this printing. However, RF Micro Devices reserves the right to make changes to its products without notice. RF Micro Devices does not assume responsibility for the use of the described product(s).

Parameter	Specification		Unit	Condition		
Falalletei	Min.	Тур.	Max.	Unit	Condition	
Operating Range						
Overall Frequency Range	800		1000	MHz	Low Band Operation	
	1800		2000	MHz	High Band Operation	
Supply Voltage (V <sub>CC</sub> )	2.7	2.8	3.0	V	VCC1 HB, VCC2 HB, VCC1 LB	
Power Down Voltage (V <sub>BIAS</sub> )	2.7	2.8	3.0	V	HB BIAS, LB BIAS	
Logic Control Voltage Level	0		3.0	V	HB SELECT, LB SELECT	
Operating Ambient Temperature	-40		+85	°C		
Input Impedance		50		Ω		
Output Impedance		50		Ω		
950MHz Performance -					T = 25°C, RF = 950MHz,	
High Gain Mode					VCC1LB=VCC2LB=2.78V, LBSelect=0V,	
Gain	14	15.5	17	٩D	$Z_{IN}=Z_{O}=50\Omega$	
Gain Gain Variation Over	14	15.5	+0.5	dB dB		
Temperature Range			<u>+</u> 0.5	uв		
Gain Variation Over			<u>+</u> 0.5	dB		
Frequency Band						
Noise Figure		1.1	2.0	dB		
Reverse Isolation	15	21		dB		
Input IP3	+2.0	+5.0		dBm		
Input P1dB	-12	-9	2:1	dB		
Input VSWR Output VSWR			2:1			
Total Current Draw		5.5	6.0	mA	900MHz LNA ENABLED, 1900MHz LNA	
		0.0	0.0	ША	DISABLED. $I_{CC} + I_{PD}$	
950 MHz Performance -					T = 25°C, RF = 950MHz,	
Bypass Mode					VCC1LB=VCC2LB=2.78V, LBSelect=2.7V, $Z_{IN}=Z_O=50\Omega$	
Gain		-6		dB		
Gain Reduction		21.5		dBc		
Input IP3	12.0	15.0		dBm		
Input P1dB	-1	+2		dB		
Input VSWR			2.5:1			
Output VSWR			2:1			
Total Current Draw					See Application Notes	

# RF2416

Devenedar	Specification		11	Constitution		
Parameter	Min.	Тур.	Max.	Unit	Condition	
1850MHz Performance - High Gain Mode					T = 25°C, RF = 1850 MHz, VCC1HB = 2.78 V, HBSelect= 0 V, $Z_{IN} = Z_O = 50 \Omega$	
Gain	16	17.5	19	dB		
Gain Variation Over Temperature Range			<u>+</u> 0.5	dB		
Gain Variation Over Frequency Band			<u>+</u> 0.5	dB		
Noise Figure		1.5	2.1	dB		
Reverse Isolation	15	20		dB		
Input IP3	-2.0	+1.0		dBm		
Input P1dB	-13	-10		dB		
Input VSWR			2:1			
Output VSWR			2:1			
Total Current Draw		9.0	9.5	mA	1900MHz LNA ENABLED, 900MHz LNA DISABLED. I <sub>CC</sub> + I <sub>PD</sub>	
1850MHz Performance -					T=25°C, RF=1850MHz, VCC1HB=2.78V,	
Bypass Mode					HBSelect=2.7V, $Z_{IN}=Z_O=50\Omega$	
Gain		-5		dB		
Gain Reduction	22	23	24	dBc		
Input IP3	12.0	15.0		dBm		
Input P1dB	+5	+8		dB		
Input VSWR			2:1			
Output VSWR			2.5:1			
Total Current Draw					See Applications Notes	
AGC Settling Time			10	μs		
Rise and Fall Time			10	μs		

## Preliminary

Pin	Function	Description	Interface Schematic
1	HB IN	DCS1800/PCS1900 RF input pin.	To Bias VCC1 HB Circuit HB IN O HB GND1
2	HB BIAS	HB BIAS is set to the supply voltage at high gain mode. For bypass mode see "Gain Select Possibility".	
3	LB BIAS	LB BIAS is set to the supply voltage at high gain mode. For bypass mode see "Gain Select Possibility".	
4	LB IN	GSM900 RF input pin.	To Bias Circuit LB IN OCLB OUT LB GND
5	LB GND	LNA emittance inductance. Total inductance is comprised of package+bondwire+L2 on PCB.	
6	LB OUT	GSM900 Amplifier Output pin. This pin is an open-collector output. It must be biased to $V_{CC}$ through a choke or matching inductor. This pin is typically matched to 50 $\Omega$ with a shunt bias/matching inductor and series blocking/matching capacitor. Refer to application schematics.	
7	LB SELECT	This pin selects high gain and bypass for GSM900. Select $\leq 0.8$ V, high gain. Select $\geq 1.8$ V, low gain.	
8	HB SELECT	This pin selects high gain and bypass for DCS1800/PCS1900. Select $\leq 0.8$ V, high gain. Select $\geq 1.8$ V, low gain.	
9	HB OUT	DCS1800 Amplifier Output pin. This pin is an open-collector output. It must be biased to $V_{CC}$ through a choke or matching inductor. This pin is typically matched to 50 $\Omega$ with a shunt bias/matching inductor and series blocking/matching capacitor. Refer to application schematics.	HB OUT

Rev A1 010628

# RF2416

Pin	Function	Description	Interface Schematic
10	HB GND2	LNA2 emittance inductance. Total inductance is comprised of package+bondwire+L5 on PCB.	
11	VCC1 HB	Open collector for first stage LNA of DCS1800/PCS1900. It must be biased to $V_{CC}$ through a choke or matching inductor.	VCC1 HB
12	HB GND1	LNA1 emittance inductance. Total inductance is comprised of package+bondwire+L7 on PCB.	

GENERAL PURPOSE AMPLIFIERS

## Preliminary

### **Application Notes**

#### **Bypass Mode Configurations**

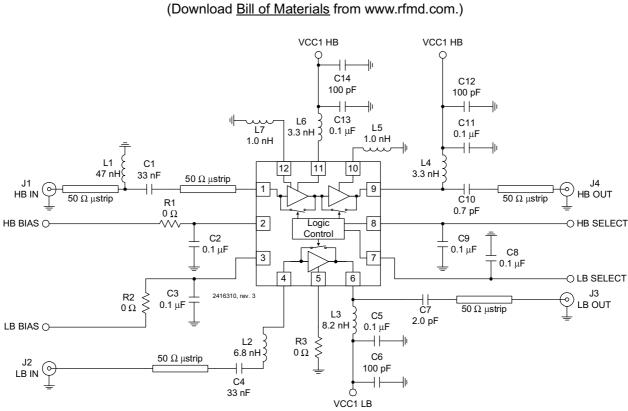
The RF2416 may be placed into either high gain or bypass mode via the HB SELECT and LB SELECT pins for high band and low band operation, respectively. The high gain state is selected by asserting the select pin for the appropriate band to a voltage level of less than 0.8 V. For Bypass operation, there are two possible methods for placing the RF2416 into this low gain state. The table below shows the two possible Bypass states for each mode.

#### **RF2416 Bypass Mode Possibilities** VCC1\_HB and VCC2\_HB (V) **Gain Select** HB BIAS (V) Current (mA) (HB Mode) 2.7 0 2.78 1.4 2.7 2.7 2.78 1.9 Gain Select LB BIAS (V) VCC1\_LB (V) Current (mA) (LB Mode) 2.7 0 2.78 0.8 2.7 2.7 2.78 1.5

For both Bypass configurations, the select pin for the appropriate band must be placed at a level greater than or equal to 1.8V. The difference between the Bypass possibilities is determined by the specific application's ability to change the voltage of the bias pins independently of  $V_{CC}$ . The advantage of the ability to assert the bias pins to 0V when in Bypass mode is shown by the decreased current draw when in this Bypass configuration.

# **RF2416**

## **Evaluation Board Schematic**



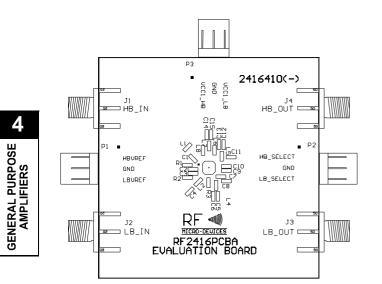
# GENERAL PURPOSE AMPLIFIERS

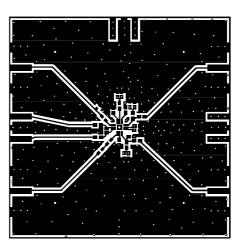
#### P2 P3 <VCC1 HB <HB BIAS P2-1 O P1-1 ()-1 1 <HB SELECT P3-1 () 1 2 -<GND ⊪ 2 <GND 2 -<GND ╟ ⊪ -<LB BIAS P2-3 ()-<LB SELECT -VCC1 LB P1-3 O- 3 3 P3-3 ()-3 CON3 СОИ3 CON3

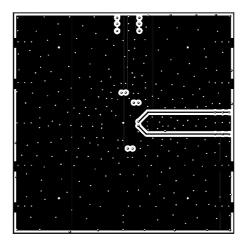
## Preliminary

#### Evaluation Board Layout Board Size 2" x 2"

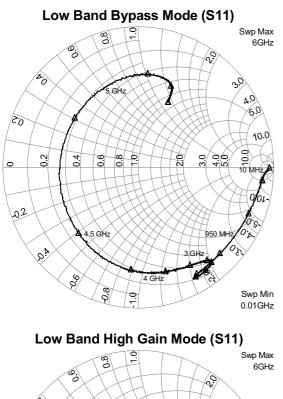
Board Thickness 0.060", Board Material FR-4, Multi-Layer

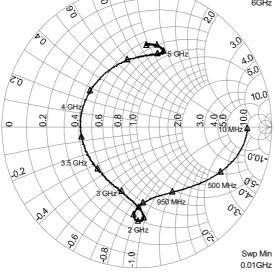






# **RF2416**





Low Band Bypass Mode (S22) Swp Max 1.0 0.8 . 6GHz o; O 80 9.0 4.0 6.0 20 10.0 0.0 10 M⊧ 0.0 5.0 0 0.2 0.4 0.0 0.8 29 0 0 ۵.2 920 MH 0.4 5/GHz 63 00 -0.8/ Swp Min 0.1 0.01GHz

Low Band High Gain Mode (S22) Swp Max 1.0 0.8 6GHz 0.0 3.9 ò 4.0 5.0 2:0 5.5 G 10.0 10.0 9. 0 5 GH 0.2 0.4 2:0 0 0'01-4.5 GH 2.2 500 MHz Q.G. 3.5 GI 950 MHz 0: 1.5 GH .0<u>^</u>A 0:

9.0

0.8

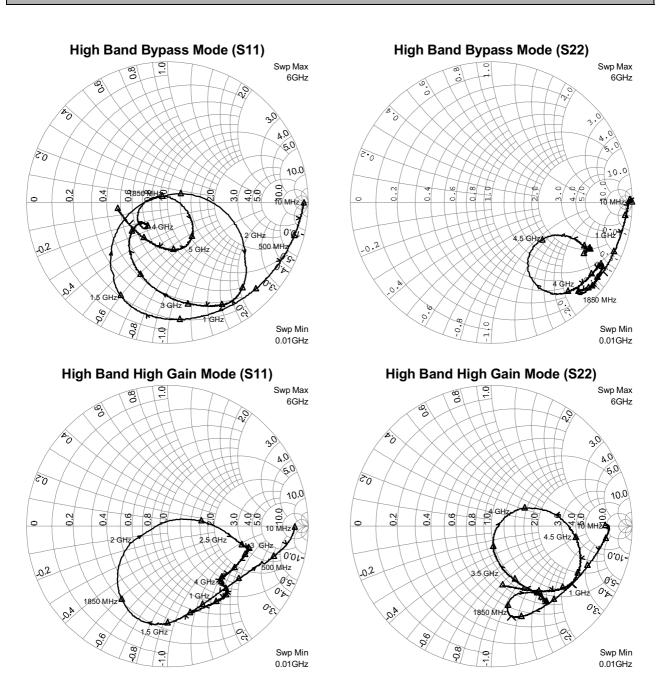
-1.0

0

Swp Min

0.01GHz

## Preliminary



#### S-Parameter Conditions:

All plots shown were taken at VCC=2.78V and Ambient Temperature=25°C.

#### Note:

All S11 and S22 plots shown were taken from an RF2416 while on a 2416310 evaluation board. The data was captured without the external input or output tuning components in place, and the reference point at the HB IN and HB OUT pins for high band and LB IN and LB OUT for low band.